



ATTORNEY DOCKET NO.: R. ADDINALL 1-1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ross Addinall, *et al.*  
Serial No.: 09/639,288  
Filed: August 15, 2000  
Title: IMPROVEMENTS IN OR RELATING TO INTEGRATED CIRCUIT DIES  
Grp./A.U.: 2814  
Examiner: Phat X. Cao

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Elizabeth Schumacher  
(Signature of the person signing the certificate)

Sir:

**AMENDMENT UNDER 37 C.F.R. § 1.111**

In response to the Examiner's Action mailed December 3, 2001, please amend the above-identified application as follows:

**IN THE SPECIFICATION:**

Please amend the title of the invention as follows:

INTEGRATED CIRCUIT DIE FOR WIRE BONDING AND FLIP-CHIP MOUNTING